## SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 8-INPUT POSITIVE-NAND GATES SDLS099 – DECEMBER 1983 – REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

#### description

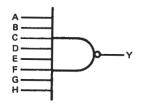
These devices contain a single 8-input NAND gate.

The SN5430, SN54LS30, and SN54S30 are characterized for operation over the full military range of -55 °C to 125 °C. The SN7430, SN74LS30, and SN74S30 are characterized for operation from 0 °C to 70 °C.

#### FUNCTION TABLE

INPUTS A THRU H	OUTPUT Y
All inputs H	L
One or more inputs L	н

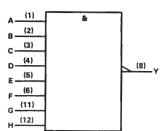
#### logic diagram



#### positive logic

$$Y = \overline{A \cdot B \cdot C \cdot D \cdot E \cdot F \cdot G \cdot H} \quad \text{or}$$
$$Y = \overline{A} + \overline{B} + \overline{C} + \overline{D} + \overline{E} + \overline{F} + \overline{G} + \overline{H}$$

logic symbol<sup>†</sup>



<sup>†</sup>This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.



SN5430 J PACKAGE
SN54LS30, SN54S30 J OR W PACKAGE
SN7430 N PACKAGE
SN74LS30, SN74S30 D OR N PACKAGE
(TOP VIEW)

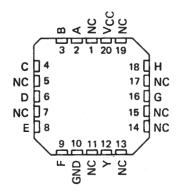
A [] B []2 C []3 D []4	U 14 UCC 13 NC 12 H 11 G
	E
D Ll₄ E Ll₅	
F C 6	
	8 J Y
_	

SN5430 W PACKAGE (TOP VIEW)									
	14 NC 13 NC 12 Y 11 GND 10 H								

#### SN54LS30, SN54S30 . . . FK PACKAGE (TOP VIEW)

8 | F

E [] 7



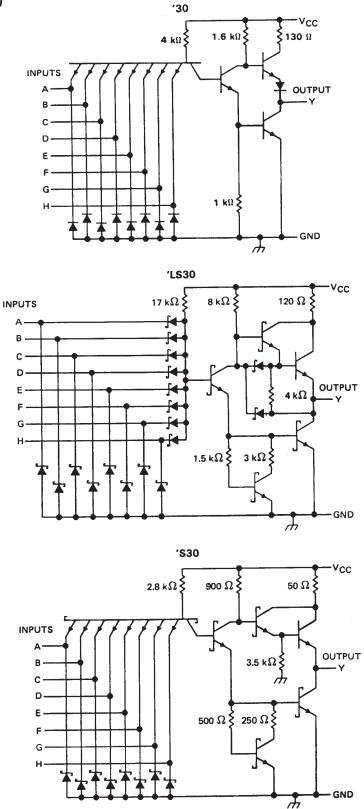
NC - No internal connection

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## SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 8-INPUT POSITIVE-NAND GATES SDLS099 – DECEMBER 1983 – REVISED MARCH 1988

#### schematics (each gate)



Resistor values shown are nominal.



# SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 **8-INPUT POSITIVE-NAND GATES**

SDLS099 – DECEMBER 1983 – REVISED MARCH 1988

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1) 7 V	/
Input voltage	'
Operating free-air temperature range: SN5430 55 °C to 125 °C	,
SN7430	
Storage temperature range	,

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			SN5430	)	SN7430			
		MIN	NOM	MAX	MIN	NOM	мах	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
ViH	High-level input voltage	2			2			v
VIL	Low-level input voltage			0.8			0.8	v
юн	High-level output current			- 0.4			- 0.4	mA
IOL	Low-level output current			16			16	mA
т <sub>А</sub>	Operating free-air temperature	- 55		125	0		70	°c

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

			SN			)		UNIT		
PARAMETER		TEST CONDI	TIONS	MIN	TYP‡	МАХ	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	l <sub>l</sub> = – 12 mA	<u> </u>			- 1.5			- 1.5	v
V <sub>OH</sub>	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = 0.8 V,	<sup>1</sup> OH ≖ − 0.4 mA	2.4	3.4		2.4	3.4		v
VOL	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OL</sub> = 16 mA		0.2	0.4		0.2	0.4	V
4	V <sub>CC</sub> = MAX,	V <sub>i</sub> = 5.5 V				1			1	mA
Чн	V <sub>CC</sub> = MAX,	VI = 2.4 V				40			40	μA
կլ	V <sub>CC</sub> = MAX,	VI = 0.4 V				- 1.6			- 1.6	mA
IOS§	V <sub>CC</sub> = MAX			- 20		- 55	- 18		- 55	mA
ICCH	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0			. 1	2		1	2	mA
ICCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5 V			3	6		3	6	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . § Not more than one output should be shorted at a time.

## switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	түр	MAX	UNIT
tPLH					13	22	ns
<sup>t</sup> PHL	Апу	Y	R <sub>L</sub> = 400 Ω, C <sub>L</sub> = 15 pF		8	15	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



# SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 8-INPUT POSITIVE-NAND GATES

SDLS099 – DECEMBER 1983 – REVISED MARCH 1988

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1)	7V
Input voltage	7V
Operating free-air temperature range: SN54LS30	-55°C to 125°C
SN74LS30	
Storage temperature range	-65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			SN54LS30 SN74LS			30	UNIT	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	v
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	v
юн	High-level output current			- 0.4			- 0.4	mA
IOL	Low-level output current			4			8	mA
TA	Operating free-air temperature	- 55		125	0		70	°c

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

					SN54LS	30		SN74LS	30	
PARAMETER		TEST CONDIT	TONST	MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,	l <sub>l</sub> = — 18 mA				- 1.5			- 1.5	v
V <sub>OH</sub>	V <sub>CC</sub> = MIN,	VIL = MAX,	I <sub>OH</sub> = - 0.4 mA	2.5	3.4		2.7	3.4		V
	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	l <sub>OL</sub> ≖ 4 mA		0.25	0.4			0.4	- v
VOL	V <sub>CC</sub> = MIN,	V <sub>1H</sub> = 2 V,	I <sub>OL</sub> = 8 mA					0.25	0.5	
Ц	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V				0.1			0.1	mA
ін	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 2.7 V				20			20	μA
IIL.	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				- 0.4			- 0.4	mA
los§	V <sub>CC</sub> = MAX		an a	- 20		- 100	- 20		- 100	mA
Іссн	V <sub>CC</sub> = MAX,	V  = 0			0.35	0.5		0.35	0.5	mA
ICCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5 V			0.6	.1.1		0.6	1.1	mA

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $\ddagger$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25<sup>o</sup>C

§ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

## switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CONDITIONS	MIN	ТҮР	MAX	UNIT
<sup>t</sup> PLH	0.514	~	B. = 340 C. = 15 a 5		8	15	ns
<sup>t</sup> PHL	Any	r	$R_L = 2 k \Omega$ , $C_L = 15 pF$		13	20	ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



# SN5430, SN54LS30, SN54S30 SN7430, SN74LS30, SN74S30 **8-INPUT POSITIVE-NAND GATES**

SDLS099 – DECEMBER 1983 – REVISED MARCH 1988

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, V <sub>CC</sub> (see Note 1) 7 V
Input voltage
Operating free-air temperature range: SN54S30
SN74S30
Storage temperature range65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

			SN54S30			SN74S30		
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	v
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.8			0.8	v
юн	High-level output current			- 1			- 1	mA
IOL	Low-level output current			20			20	mA
TA	Operating free-air temperature	55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

	TEST CONDITIONS T				SN54S30			SN74S30			
PARAMETER				MIN	TYP‡	MAX	MIN	түр‡	МАХ	UNIT	
VIK	V <sub>CC</sub> = MIN,	1 <sub>l</sub> = –18 mA				-1.2			-1.2	v	
∨он	V <sub>CC</sub> = MIN,	V <sub>IL</sub> = 0.8 V,	1 <sub>OH</sub> = - 1 mA	2.5	3.4		2.7	3.4		v	
VOL	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	1 <sub>OL</sub> = 20 mA			0.5			0.5	v	
·	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 5.5 V				1			1	mA	
Чн	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 2.7 V				50			50	μA	
LIL.	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.5 V				-2			-2	mA	
IOS §	V <sub>CC</sub> = MAX			-40		-100	-40		-100	mA	
Іссн	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 0			3	5		3	5	mA	
<sup>I</sup> CCL	V <sub>CC</sub> = MAX,	V <sub>I</sub> = 4.5 V			5.5	10		5.5	10	mA	

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

‡ All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

\$ Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

## switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN	түр	MAX	UNIT	
<sup>t</sup> ₽⊾H			R <sub>L</sub> = 280 Ω,	Ci = 15 pF		4	6	ns
<sup>t</sup> PHL			n 200 <i>st</i> ,			4.5	7	ns
<sup>t</sup> PLH	Any	Y F		0 - 50 - 5		5.5		ns
<sup>t</sup> PHL			$R_{L} = 280 \Omega$ ,	С <sub>L</sub> = 50 рF		6.5		ns

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.





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6-Dec-2006

## **PACKAGING INFORMATION**

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	n MSL Peak Temp <sup>(3)</sup>
5962-9679201Q2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
5962-9679201QCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
5962-9679201QCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
5962-9679201QDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
5962-9679201QDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/30009B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30009B2A	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
JM38510/30009BCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30009BCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30009BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/30009BDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/30009SCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30009SCA	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
JM38510/30009SDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
JM38510/30009SDA	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SN5430J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SN5430J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS30J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SN54LS30J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S30J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SN54S30J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SN7430N	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN7430N	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN74LS30D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30D	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30DE4	ACTIVE	SOIC	D	14	50	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30DR	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30DRE4	ACTIVE	SOIC	D	14	2500	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74LS30J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74LS30N	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS30N	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type

# PACKAGE OPTION ADDENDUM

TEXAS JMENTS www.ti.com

6-Dec-2006

Orderable Device	Status <sup>(1)</sup>	Package Type	Package Drawing	Pins	Package Qty	e Eco Plan <sup>(2)</sup>	Lead/Ball Finish	MSL Peak Temp <sup>(3)</sup>
SN74LS30N3	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN74LS30N3	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN74LS30NE4	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS30NE4	ACTIVE	PDIP	Ν	14	25	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type
SN74LS30NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30NSR	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74LS30NSRE4	ACTIVE	SO	NS	14	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM
SN74S30D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74S30D	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74S30DR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74S30DR	OBSOLETE	SOIC	D	14		TBD	Call TI	Call TI
SN74S30J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74S30J	OBSOLETE	CDIP	J	14		TBD	Call TI	Call TI
SN74S30N	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SN74S30N	OBSOLETE	PDIP	Ν	14		TBD	Call TI	Call TI
SNJ5430J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ5430J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ5430W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ5430W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54LS30FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS30FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54LS30J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS30J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54LS30W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54LS30W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54S30FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S30FK	ACTIVE	LCCC	FK	20	1	TBD	POST-PLATE	N / A for Pkg Type
SNJ54S30J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S30J	ACTIVE	CDIP	J	14	1	TBD	A42 SNPB	N / A for Pkg Type
SNJ54S30W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type
SNJ54S30W	ACTIVE	CFP	W	14	1	TBD	A42	N / A for Pkg Type

<sup>(1)</sup> The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs. LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect. NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design. **PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check



http://www.ti.com/productcontent for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

<sup>(3)</sup> MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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J (R-GDIP-T\*\*) 14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F14)

CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package can be hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only.
  - E. Falls within MIL STD 1835 GDFP1-F14 and JEDEC MO-092AB



MLCC006B - OCTOBER 1996

## FK (S-CQCC-N\*\*)

## LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a metal lid.
- D. The terminals are gold plated.
- E. Falls within JEDEC MS-004



# N (R-PDIP-T\*\*)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



NOTES:

- A. All linear dimensions are in inches (millimeters).B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- $\triangle$  The 20 pin end lead shoulder width is a vendor option, either half or full width.



D (R-PDSO-G14)

PLASTIC SMALL-OUTLINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 (0,15) per end.

Body width does not include interlead flash. Interlead flash shall not exceed .017 (0,43) per side.

E. Reference JEDEC MS-012 variation AB.



## MECHANICAL DATA

## PLASTIC SMALL-OUTLINE PACKAGE

#### 0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 $\bigcirc$ Gage Plane ₽ 0,25 7 1 1,05 0,55 0-10 Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS \*\* 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G\*\*)

**14-PINS SHOWN** 

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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